

IEC 62319-1
(First edition – 2005)

Polymeric thermistors –
Directly heated positive step function temperature coefficient –

Part 1: Generic specification

CORRIGENDUM 1

2.3.2
Bump test severities

Replace the title and the entire paragraph by the following entry:

2.3.2

Void

2.3.4
Vibration severities

Replace, in the fourth paragraph, “98 m/s²” by “100 m/s²”.

3.5.7.2
Assessment level

Replace in Table 2, third column, “3)” by “c”. <https://standards.iteh.ai/catalog/standards/iec/ff85b6aa-b257-41a7-9412-73af7ccc4315/iec-62319-1-2005-cor1-2009>

4.8.1
Solderability

Replace, in the first sentence, “The thermistors shall be subjected to Test Ta of IEC 60068-2-20...” by “The thermistors shall be subjected to Test Tb of IEC 60068-2-20...”.

4.11.2
Dry heat

Replace, in the first sentence, “The thermistors shall be subjected to the procedure of Test Ba of IEC 60068-2-2...” by “The thermistors shall be subjected to the procedure of Test Bd of IEC 60068-2-2...”.

Annex A
Fixed sample size test schedules for qualification approval

Replace the numbering of item d) as follows:

Instead of “D” insert “d”.